micro resist technology GmbH Köpenicker Straße 325 12555 Berlin Germany Tel.: +49 (0) 30 641670100 Fax: +49 (0) 30 641670200

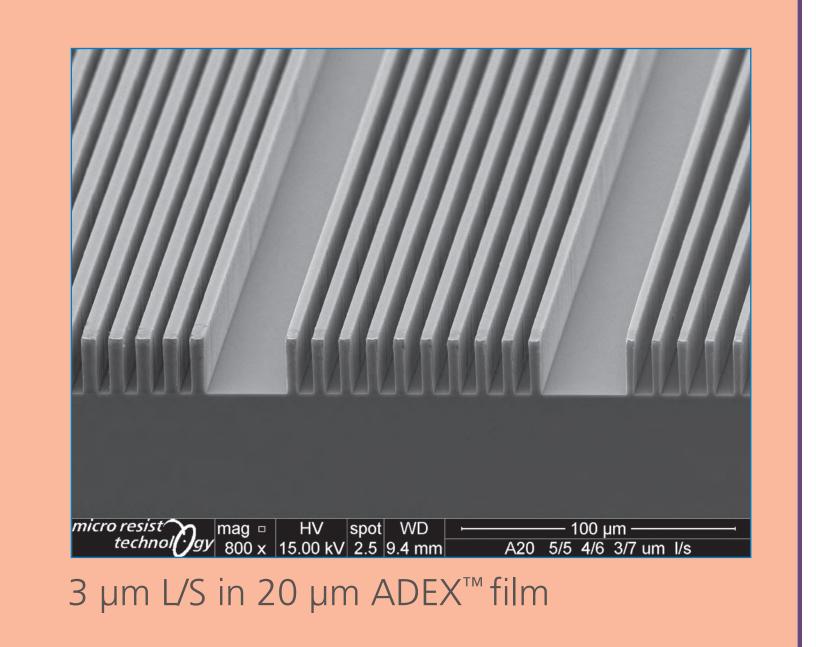
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www.microresist.com



Dry Film Photoresists

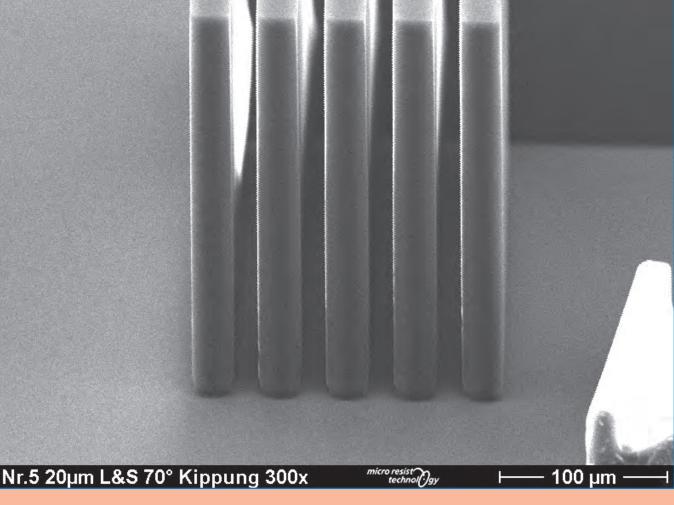
Dry film Resists for MEMS, Microfluidics and Packaging applications



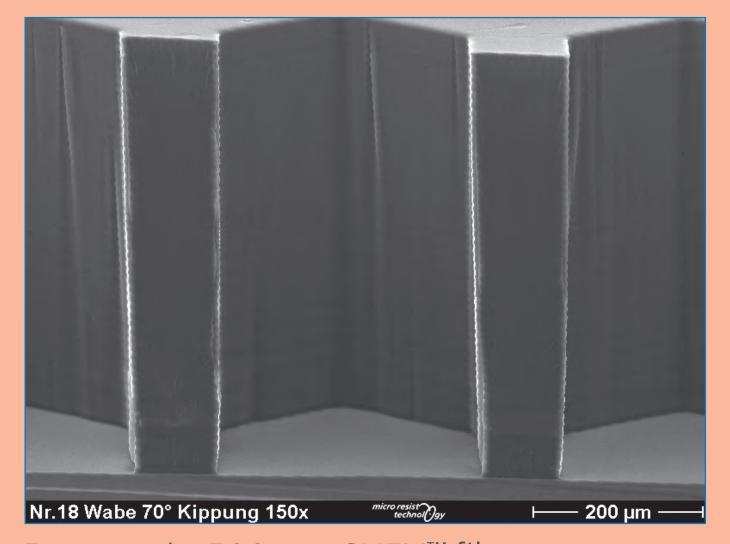
5 μm L/S in 50 μm ADEX™ film



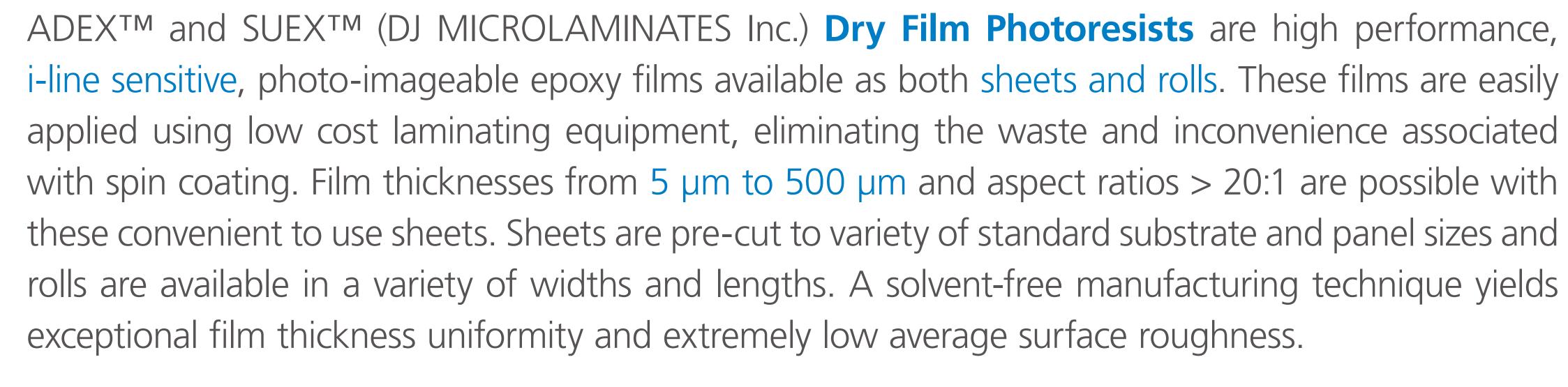
(multiple lamination)



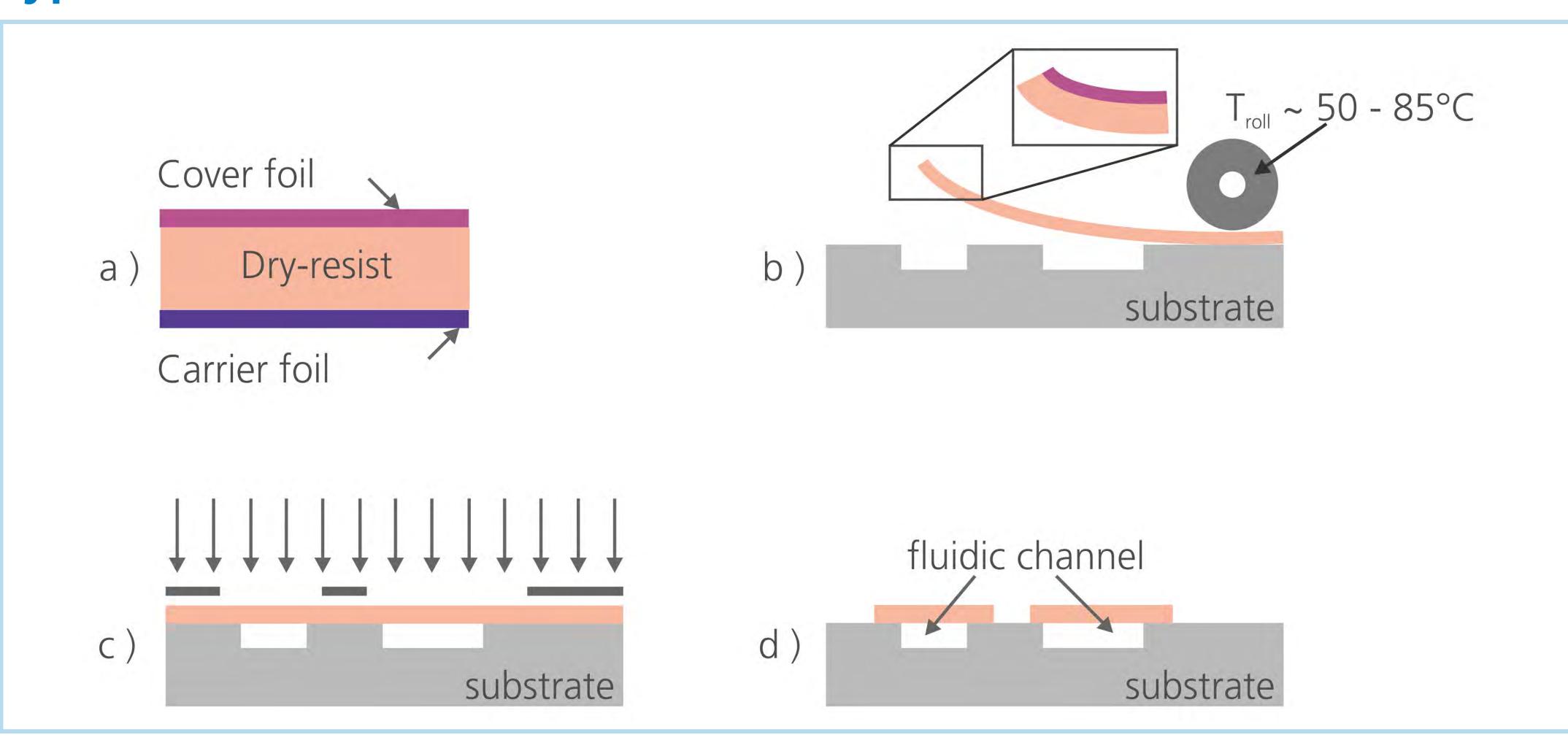
L/S features in 250 µm SUEX™ film



Features in 500 µm SUEX[™] film



Typical Process:



Remove PET cover foil ⇒ Laminate using vacuum or hot roll laminator ⇒ Soft Bake: 85 – 95 °C ⇒ Remove PET foil ⇒ Expose: i-line ⇒ Develop: mr-Dev 600, immersion ⇒ Hard Bake (optional): 125 – 200 °C

Items in this series:

Resist	Film thickness Sheet/ roll sizes*	Developer
ADEX TM A	5 μm; 10 μm; 15 μm; 20 μm Pre-cut sheets (wafer cut sizes, round/ square/ rectangular) and rolls	mr-Dev 600, mr-Dev CH (for high resolution features)
SUEX TM K	20 μm; 25 μm; 30 μm; 40 μm; 50 μm; 75 μm; 100 μm; 125 μm; 150 μm; 200 μm; 225 μm; 250 μm; 300 μm; 350 μm; 500 μm Pre-cut sheets (wafer cut sizes, round/ square/rectangular)	mr-Dev 600
	* Other sheets sizes and rolls on request	

Applications:

Plating moulds

Polymer MEMS

Microfluidics

Spacers

Wafer Level Packaging



micro resist technology GmbH is a distributor of DJ Microlaminates Dry Film Photoresists for MEMS, microfluidics and packaging applications.